



景碩科技股份有限公司
Kinsus Interconnect Technology Co.

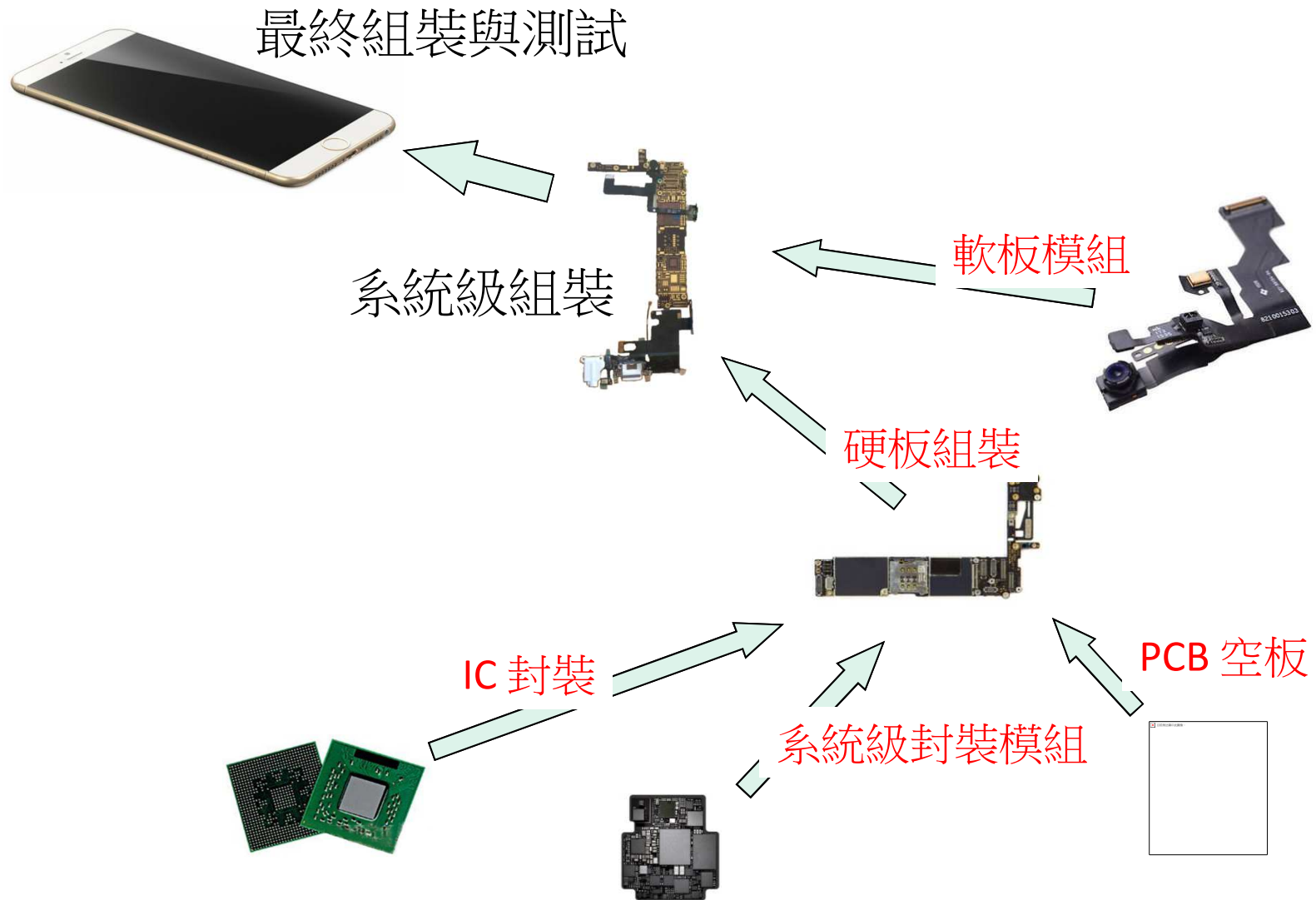
2019 March



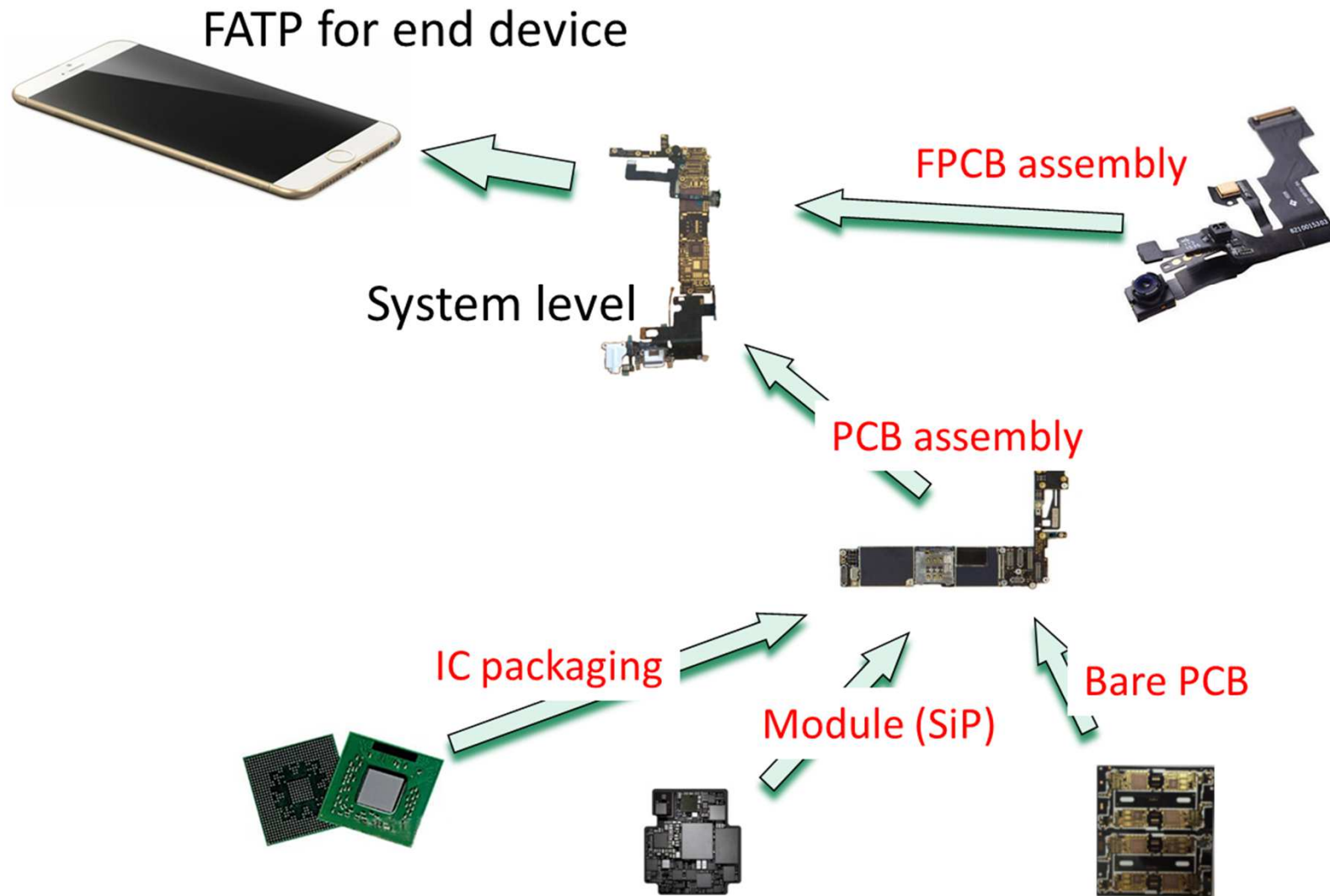
IC 封裝技術

IC Packaging Technology

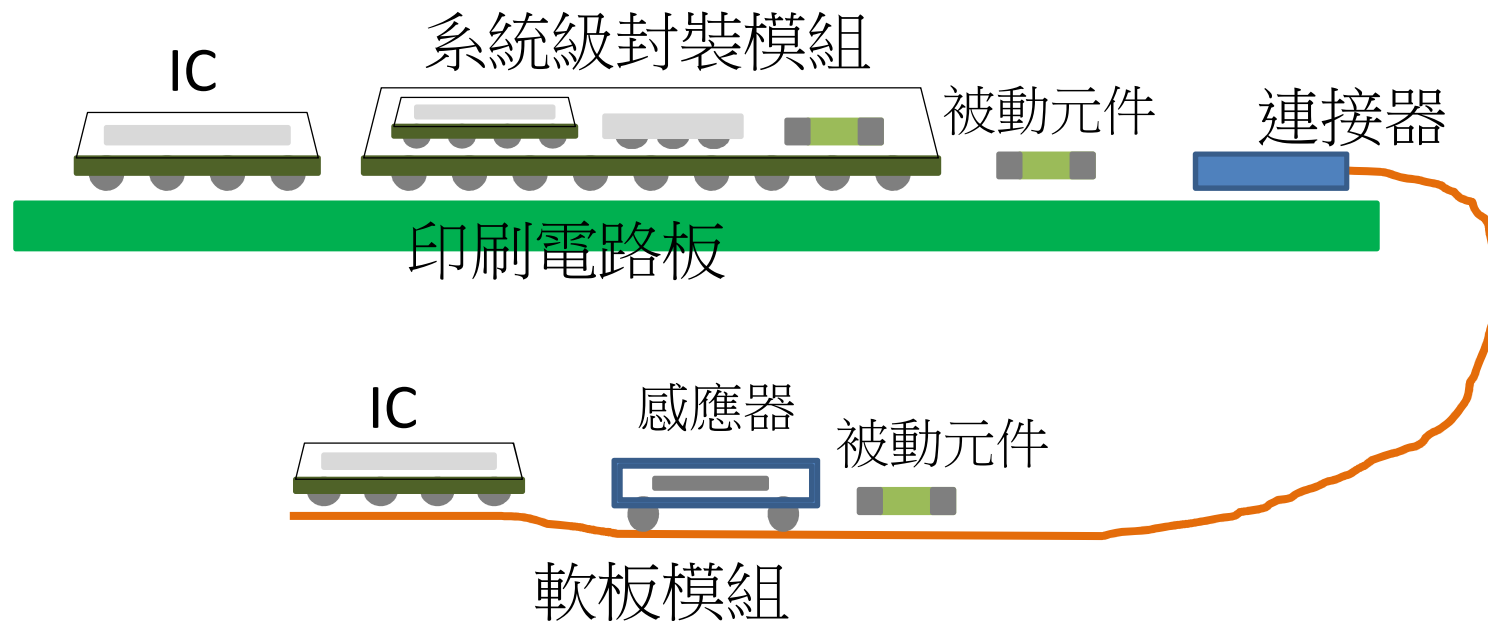
電子產品構裝的各個層次



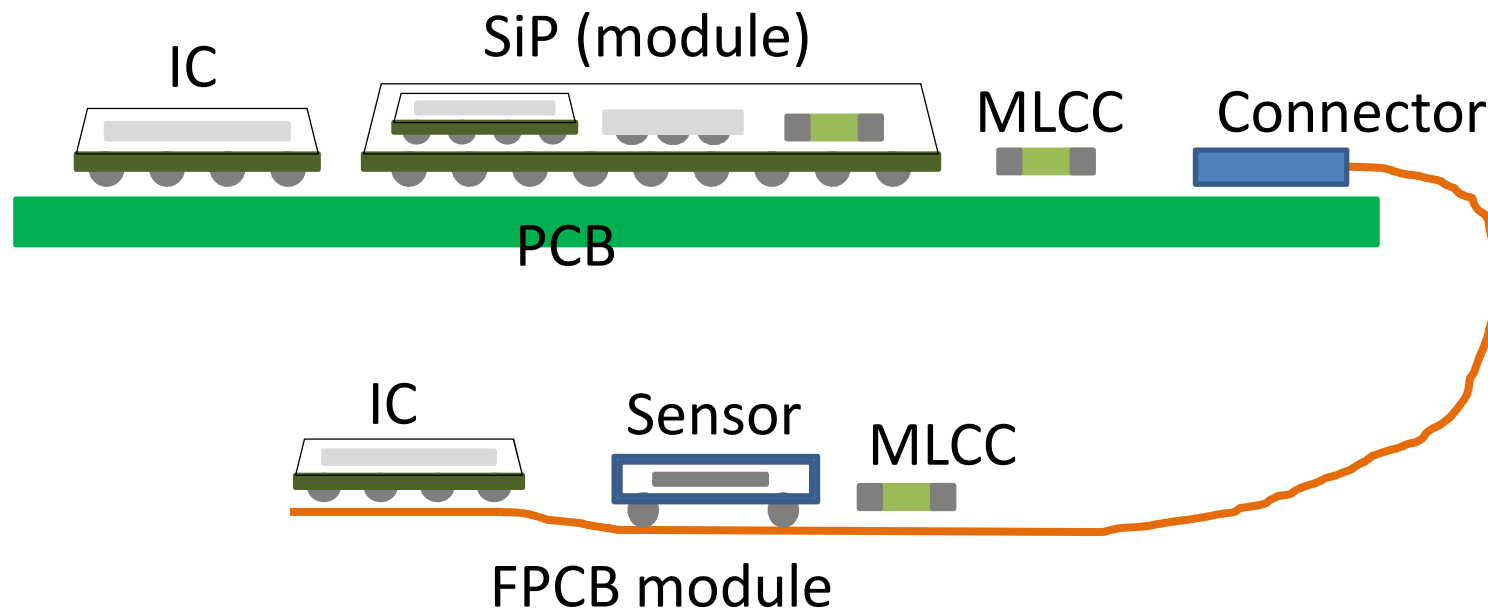
Levels of Assembly



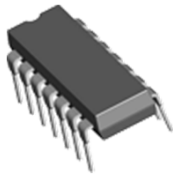
電子產品的組裝結構



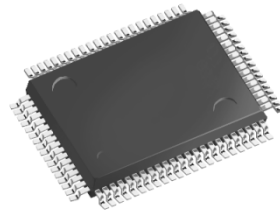
Components in Electronic Device Assembly



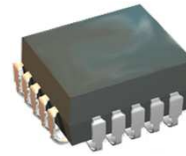
各種形式的 IC 封裝



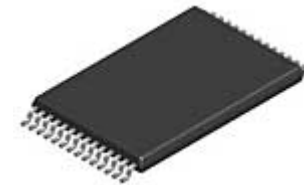
DIP



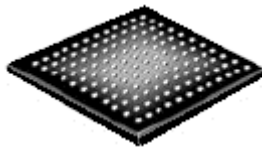
QFP



PLCC



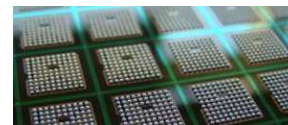
TSOP



PBGA/
Flip-Chip BGA



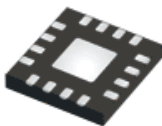
CSP



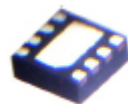
WLP



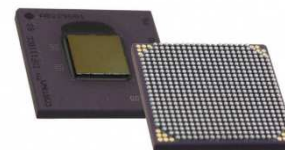
TSV



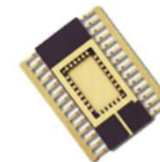
QFN



DFN



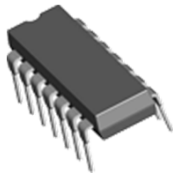
Ceramic BGA



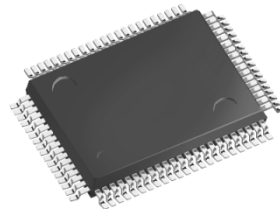
Ceramic chip

市場規模: 252 Billion units in 2016

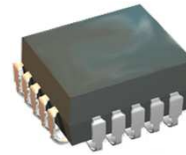
Different types of IC packaging



DIP



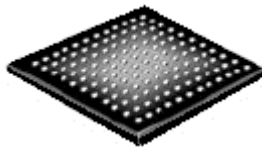
QFP



PLCC



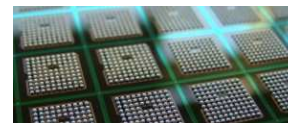
TSOP



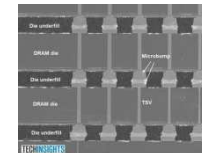
PBGA/
Flip-Chip BGA



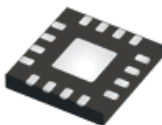
CSP



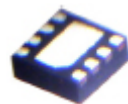
WLP



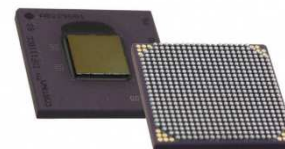
TSV



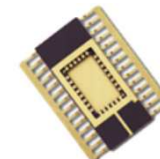
QFN



DFN



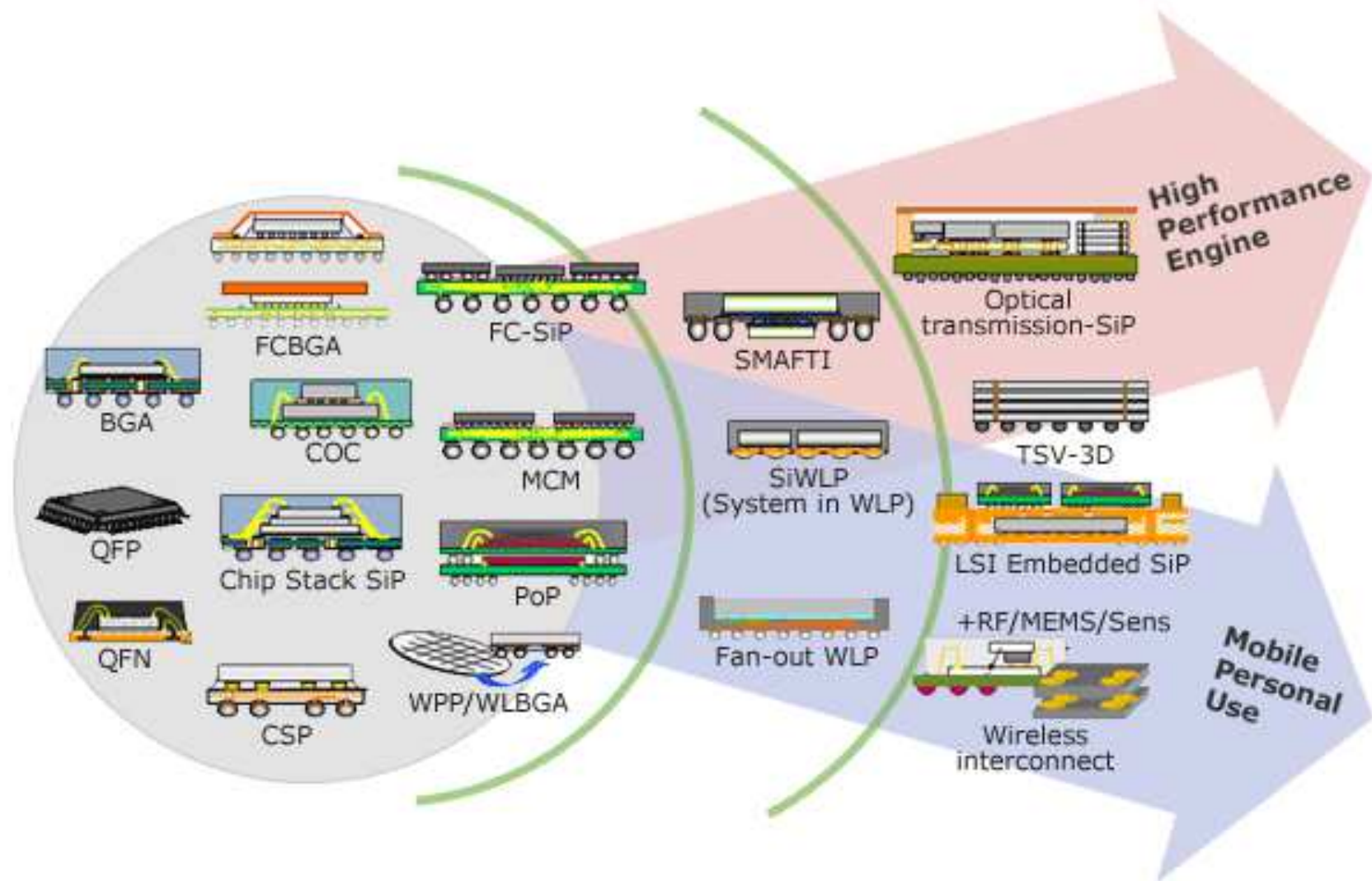
Ceramic BGA



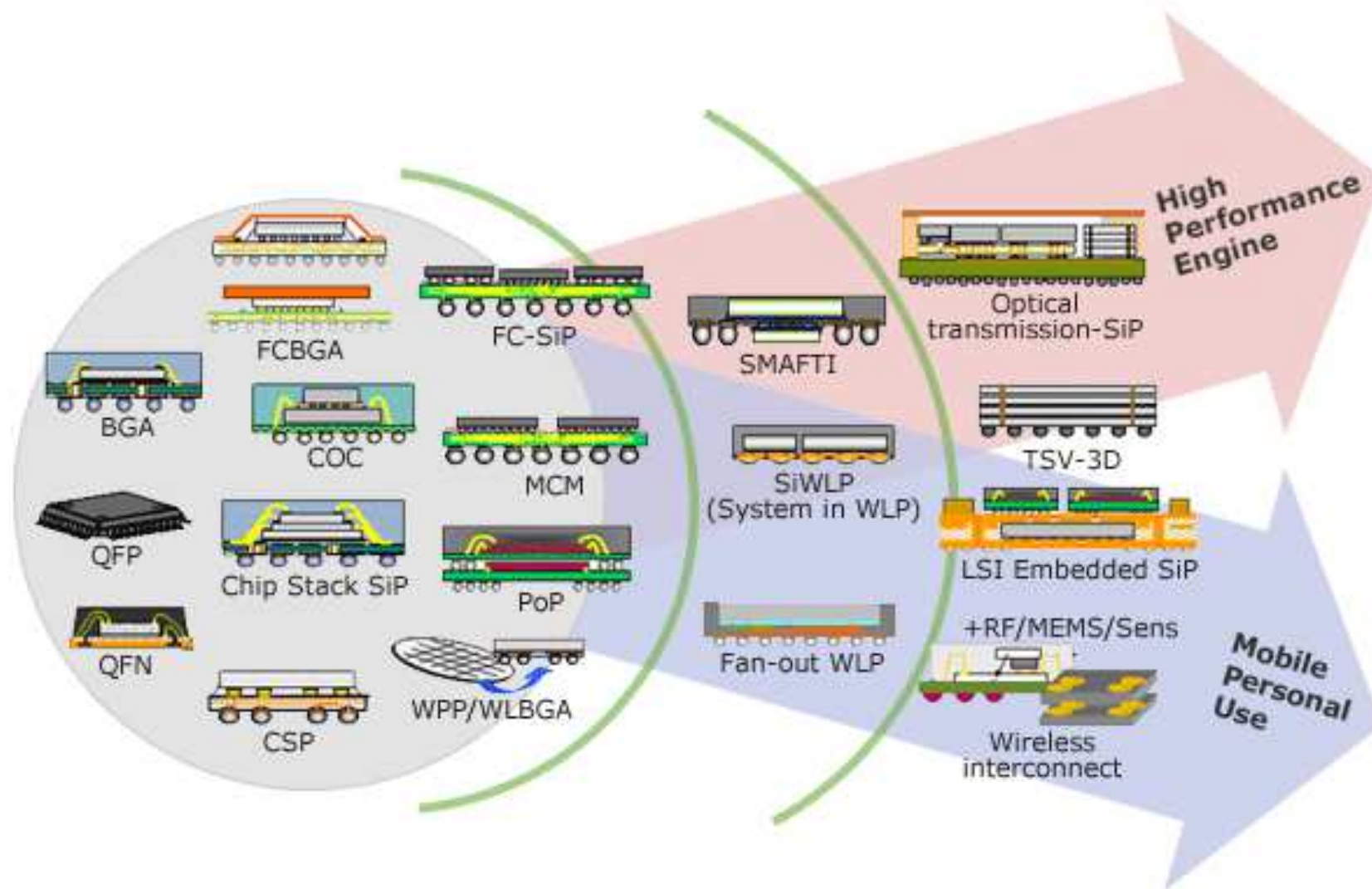
Ceramic chip

Market size : 252 Billion units in 2016

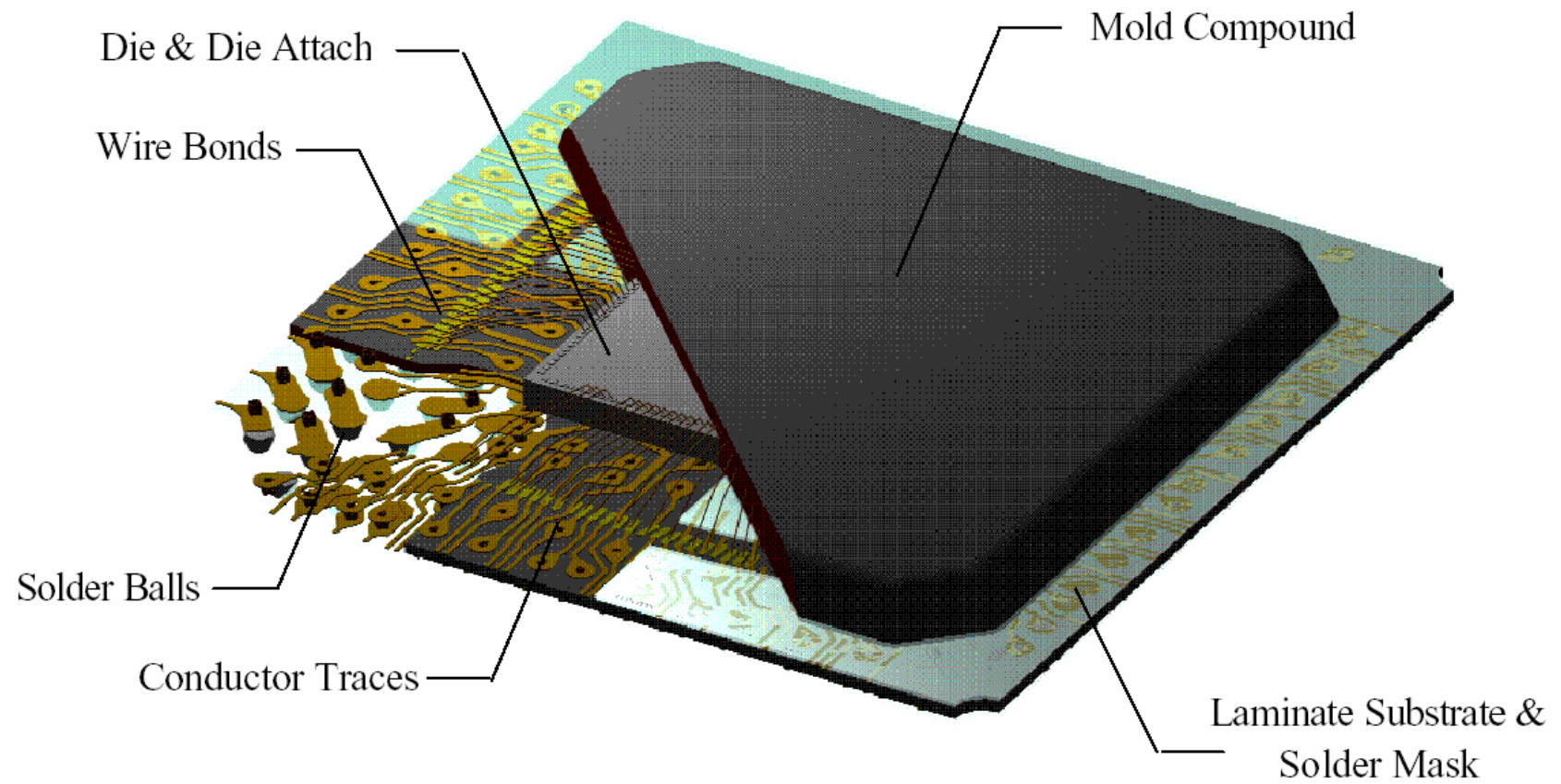
封裝技術走向



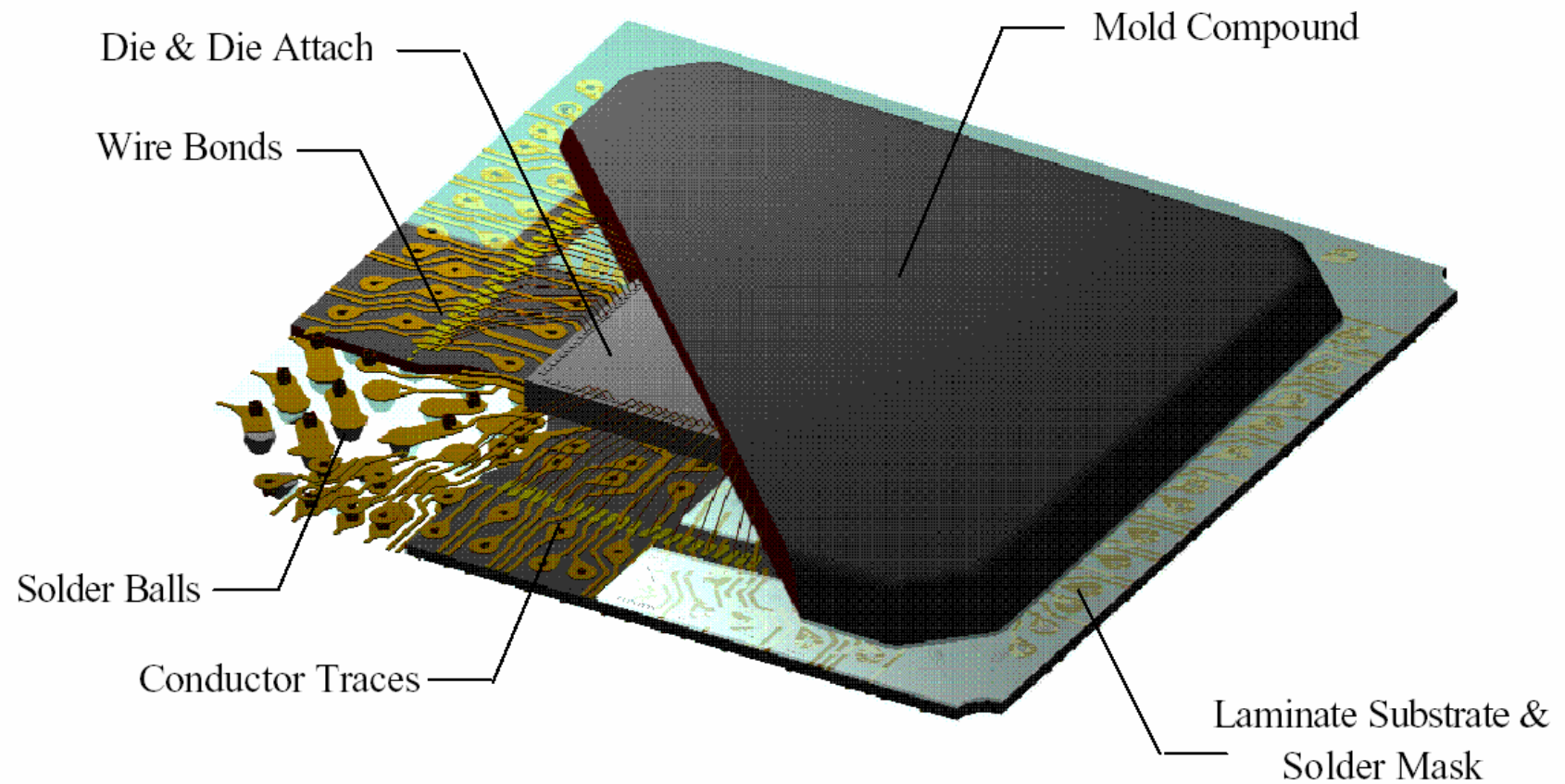
Packaging Technology Roadmap



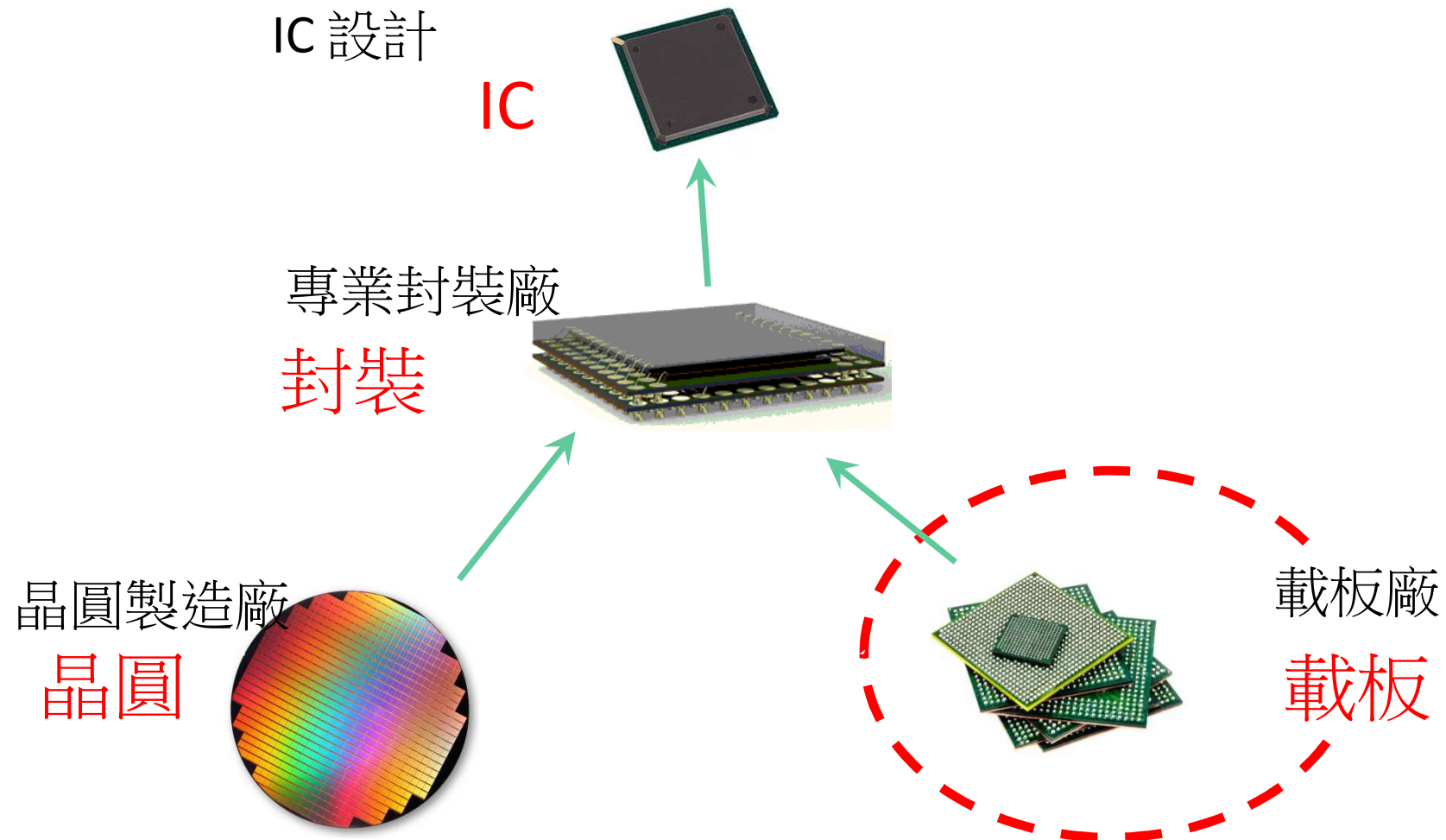
IC 結構



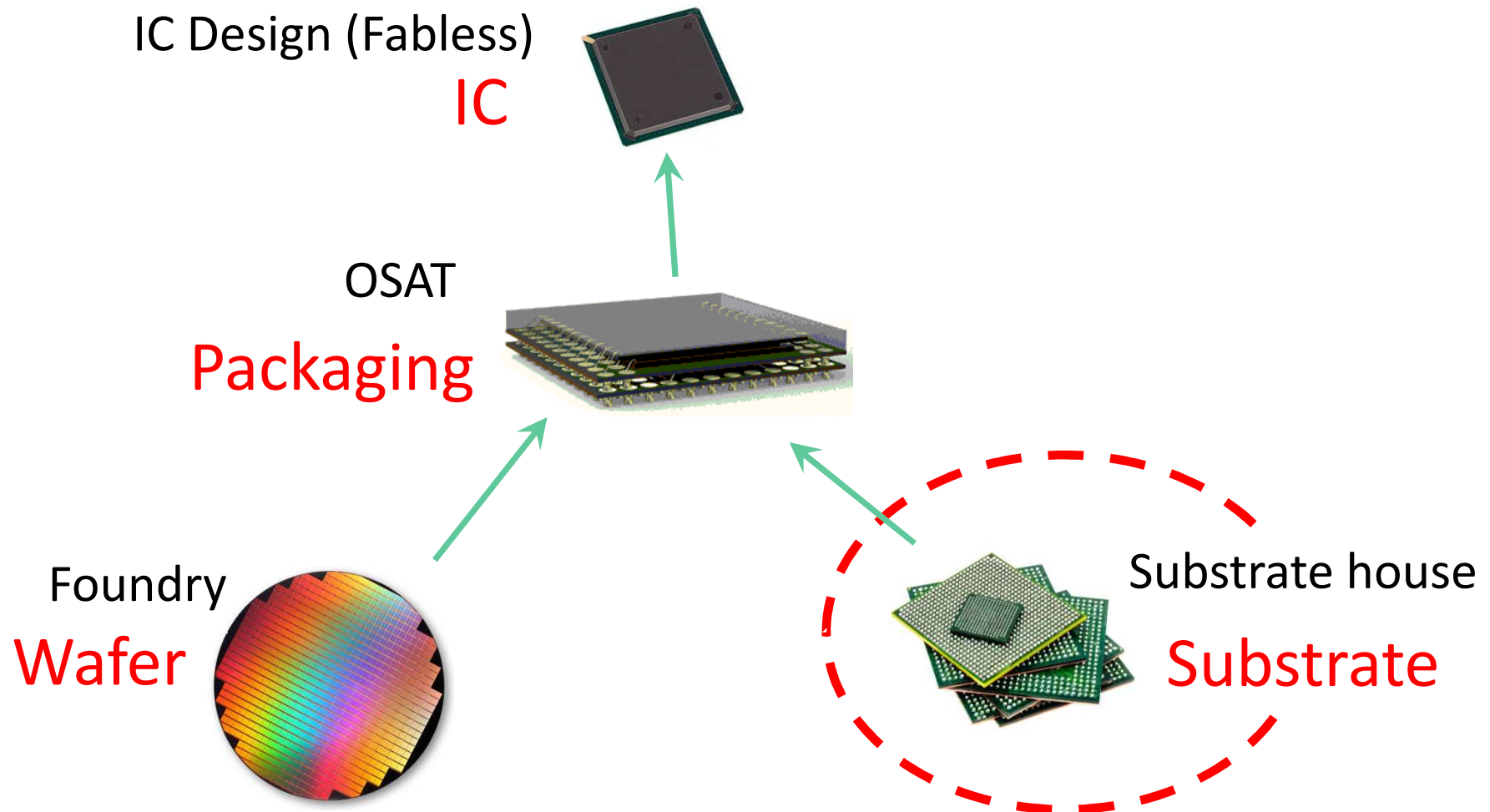
What Substrate Makers do?



IC 半導體上下游供應鏈關係



IC Manufacturing Supply Chain





About Kinsus

基本資料



- 成立 September 2000
上市 November 2004
- 登記資本額 新台幣 44.6 億
- 廠區：
 - 總部
 - 新屋區 / 桃園市
 - 一廠, 二廠
 - 五廠
 - 美國子公司
 - Santa Clara / California
 - 中國子公司
 - 蘇州
 - 蘇州百碩電腦
 - 蘇州

Basic Information



- Established in September 2000
IPO in November 2004
- Capital : US\$ 154 Million (NT\$ 4.46 Billion)
- Campus :

Headquarters	- Xin Wu / Taoyuan
Rigid Substrates BU	- Plant I, Plant II
	- Plant V
Kinsus USA	- Santa Clara / California
Kinsus China	- Suzhou
Piotek Computer	- Suzhou



A photograph of a large, modern, multi-story building with a curved facade and extensive glass windows. The building is surrounded by green grass and a paved walkway. The sky is overcast.

ou (統碩)

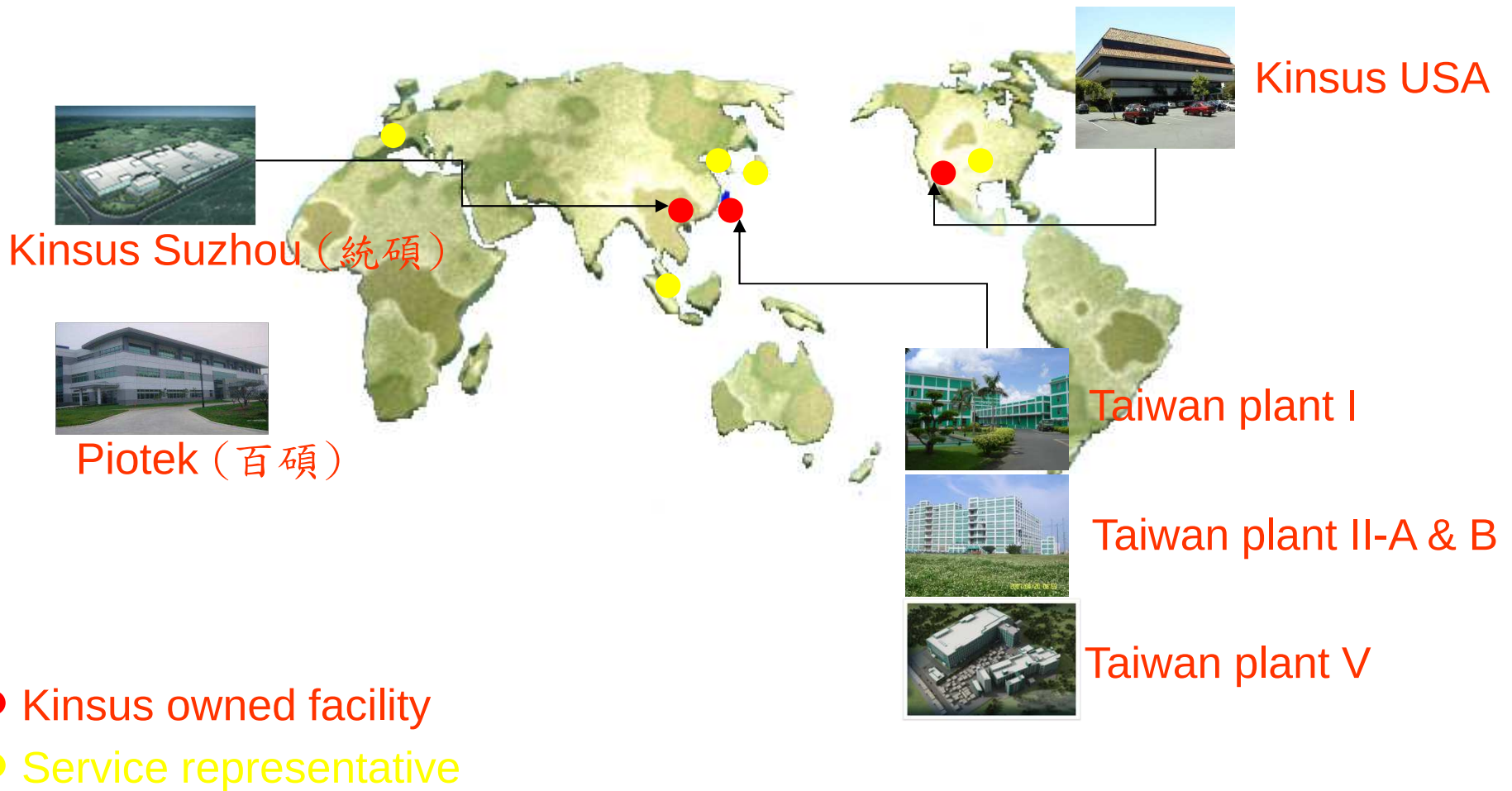
碩)



五廠

- 景碩自有廠房辦公室
- 業務代表/代理

Locations



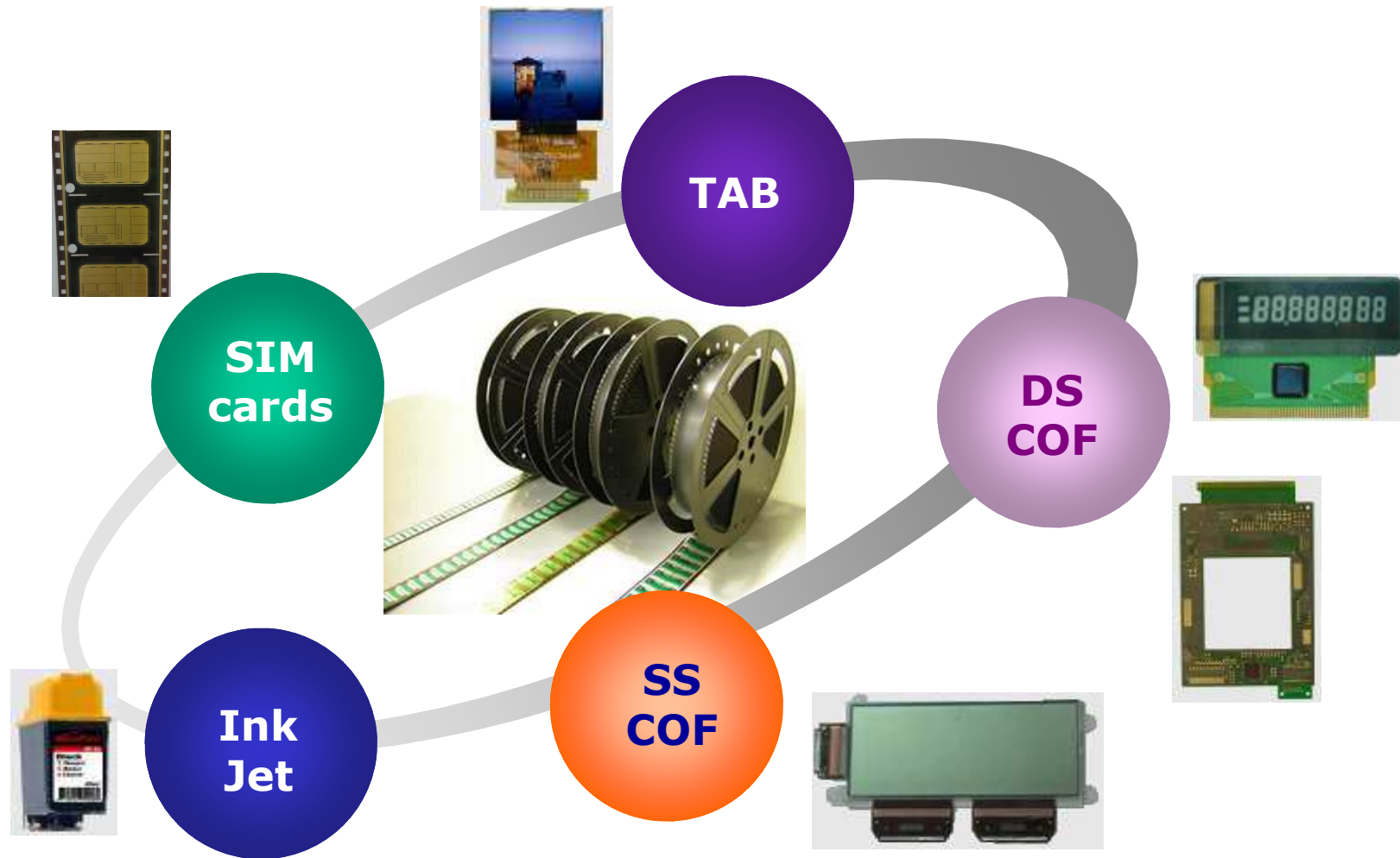
硬質載板產品



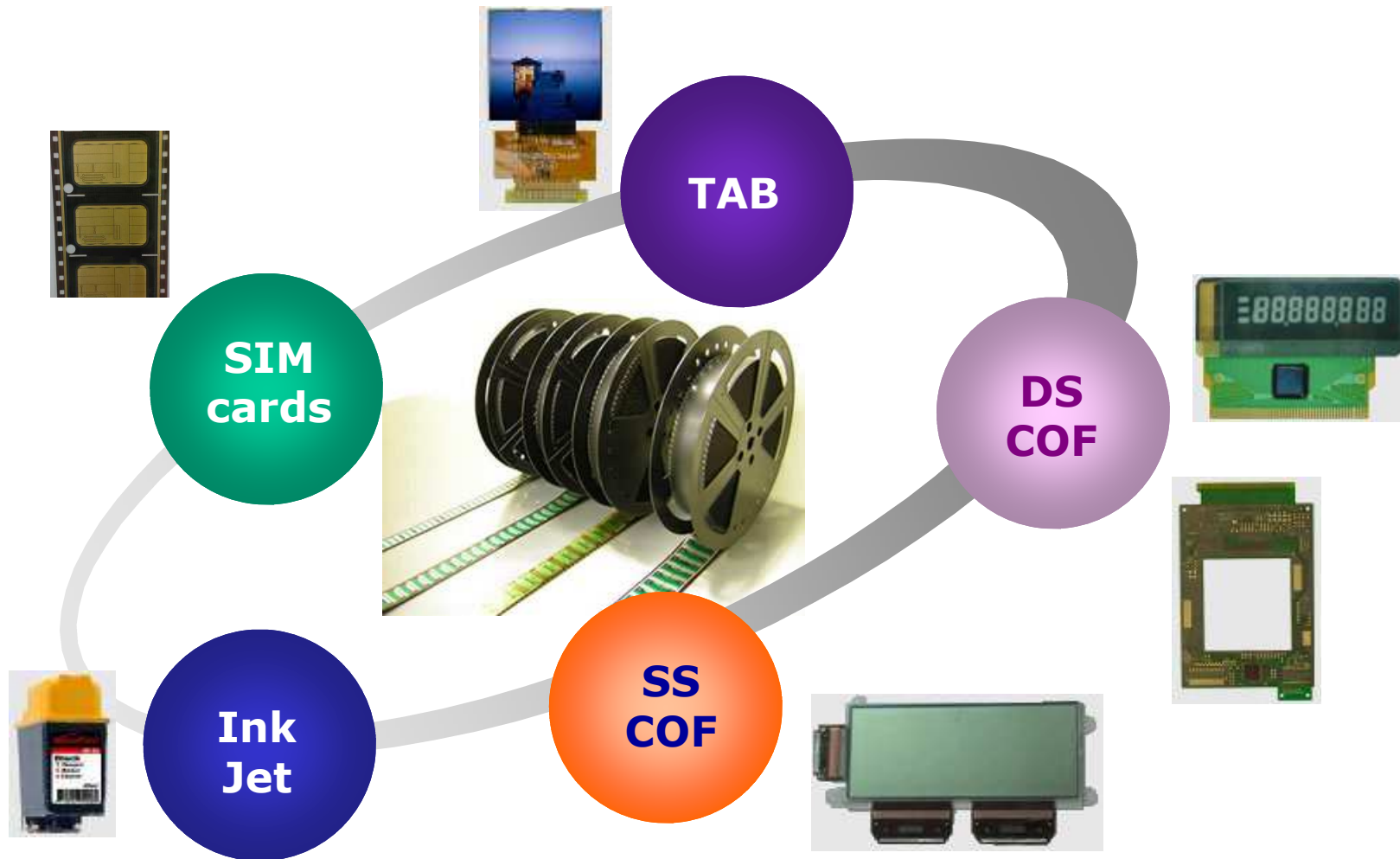
Rigid Substrate Products



軟質載板產品



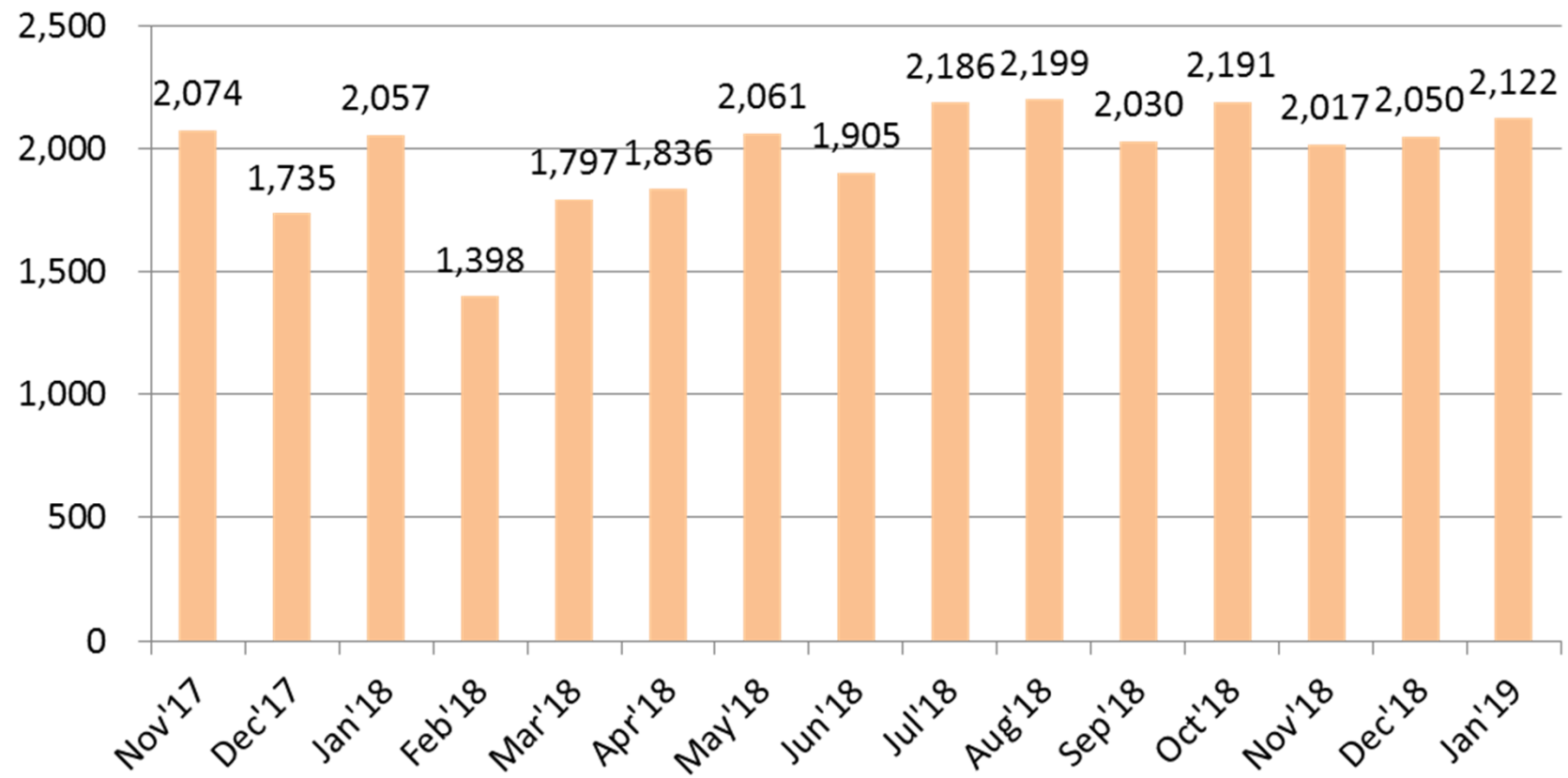
Flexible Substrate Products



每月營業額



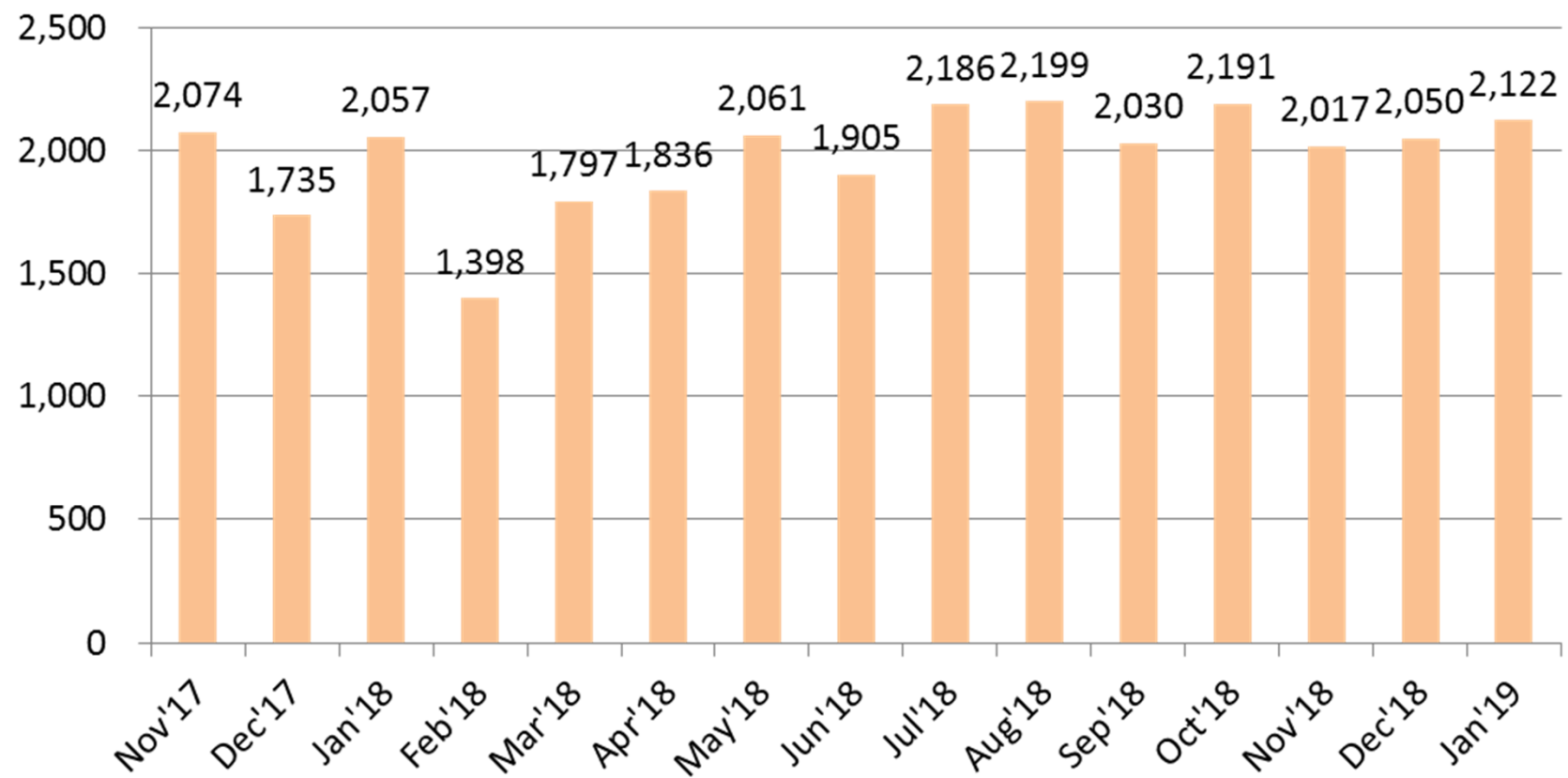
單位：新台幣百萬元



Monthly Revenue



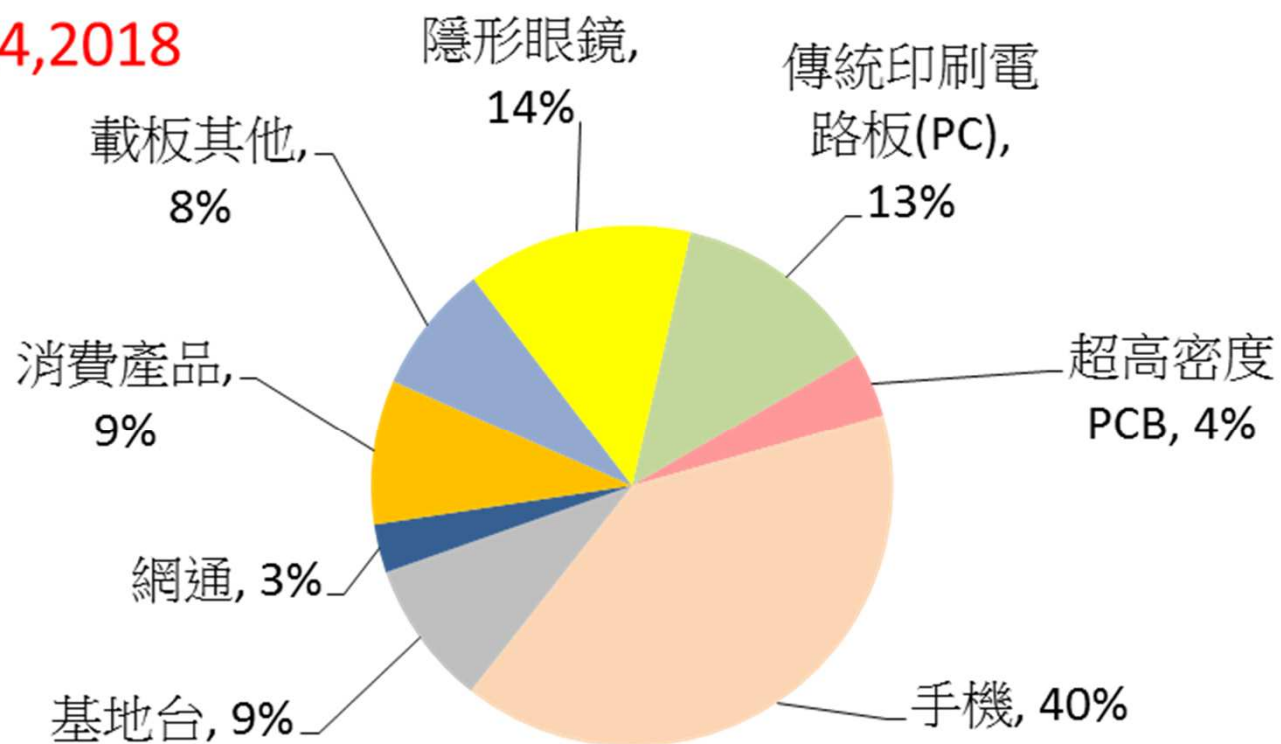
Unit : Million NT\$



產品組合－依應用別



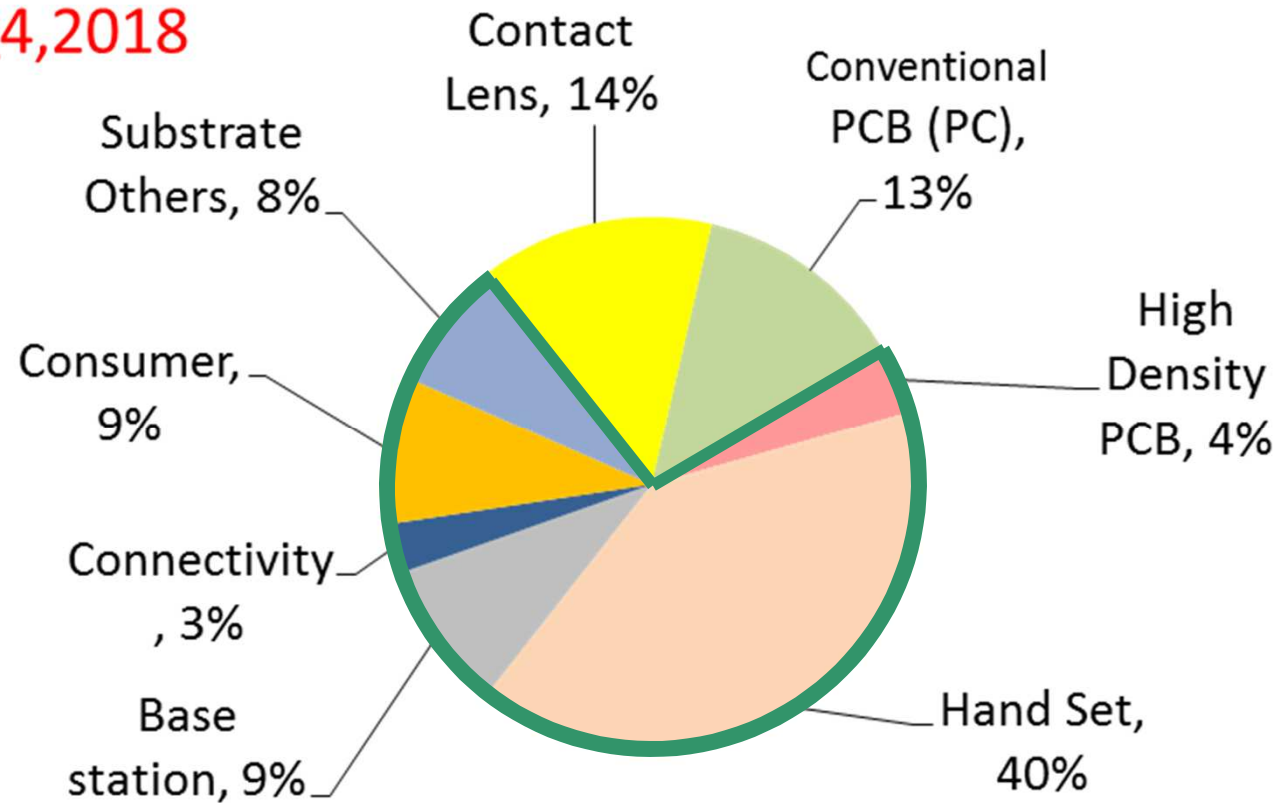
Q4,2018



Product mix – by Applications



Q4,2018





Thank You!